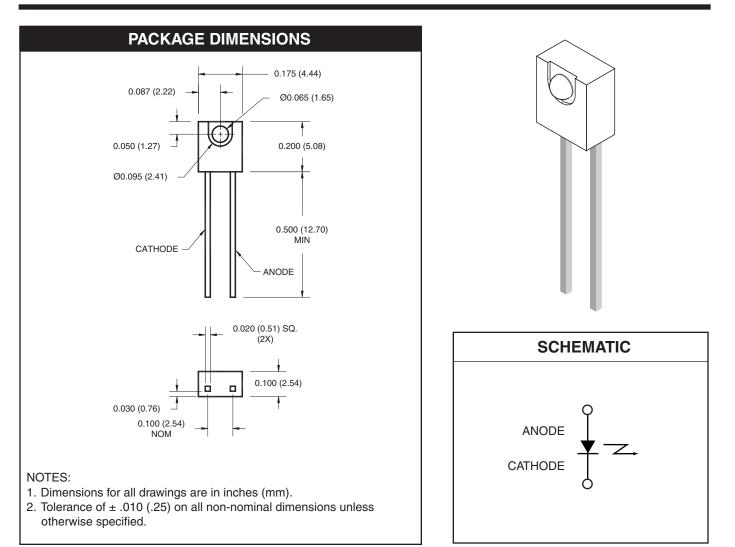


# PLASTIC INFRARED LIGHT EMITTING DIODE

### **QEE122 QEE123**



### DESCRIPTION

The QEE12X is a 880 nm AlGaAs LED encapsulated in a medium wide angle, plastic sidelooker package.

### FEATURES

- λ= 880 nm
- Package Type = Sidelooker
- Chip Material = AlGaAs
- Matched Photosensor: QSE113
- Medium Wide Emission Angle, 50°
- Package Material: Clear Epoxy
- High Output Power
- Orange stripe on the top side



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## **QEE122 QEE123**

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25°C unless otherwise specified)								
Parameter	Symbol	Rating	Unit					
Operating Temperature	T <sub>OPR</sub>	-40 to + 100	°C					
Storage Temperature	T <sub>STG</sub>	-40 to + 100	°C					
Soldering Temperature (Iron) <sup>(2,3,4)</sup>	T <sub>SOL-I</sub>	240 for 5 sec	°C					
Soldering Temperature (Flow) <sup>(2,3)</sup>	T <sub>SOL-F</sub>	260 for 10 sec	°C					
Continuous Forward Current	١ <sub>F</sub>	50	mA					
Reverse Voltage	V <sub>R</sub>	5	V					
Power Dissipation <sup>(1)</sup>	P <sub>D</sub>	100	mW					

#### NOTES:

1. Derate power dissipation linearly 1.33 mW/°C above 25°C.

2. RMA flux is recommended.

3. Methanol or isopropyl alcohols are recommended as cleaning agents.

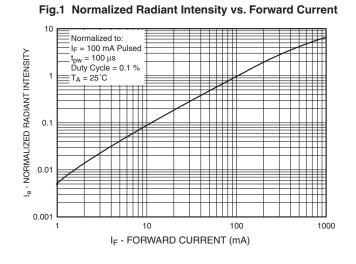
4. Soldering iron 1/16" (1.6 mm) minimum from housing

ELECTRICAL / OPTICAL CHARACTERISTICS (T <sub>A</sub> =25°C)								
Parameter	Test Conditions	Symbol	Min	Тур	Max	Units		
Peak Emission Wavelength	I <sub>F</sub> = 100 mA	λ <sub>PE</sub>		940	_	nm		
Emission Angle	I <sub>F</sub> = 100 mA	201/2	_	50	—	Deg.		
Forward Voltage	I <sub>F</sub> = 100 mA, tp = 20 ms	V <sub>F</sub>	_	_	1.7	V		
Reverse Current	V <sub>R</sub> = 5 V	I <sub>R</sub>	_	_	10	μA		
Radiant Intensity QEE122	I <sub>F</sub> = 100 mA, tp = 20 ms	١ <sub>E</sub>	4	_	16	mW/sr		
Radiant Intensity QEE123	I <sub>F</sub> = 100 mA, tp = 20 ms	١ <sub>E</sub>	8	_	—	mW/sr		
Rise Time	- I <sub>F</sub> = 100 mA	t <sub>r</sub>	—	800	—	ns		
Fall Time		t <sub>f</sub>	_	800	_	ns		



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## QEE122 QEE123



### Fig.2 Coupling Characteristics of QEE123 And QSE113

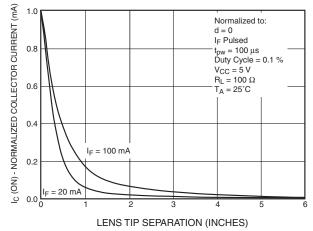
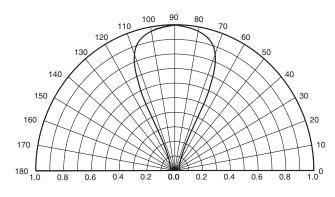


Fig. 4 Normalized Intensity vs. Wavelength

#### Fig.3 Forward Voltage vs. Ambient Temperature

2.0 1.0  $I_{F} = 50 \text{ mA}$ 0.9 NORMALIZED RADIANT INTENSITY I<sub>F</sub> = 100 mA 0.8 VF - FORWARD VOLTAGE (V) 1.5 0.7 0.6 I<sub>F</sub> = 10 mA I<sub>F</sub> = 20 mA 0.5 1.0 0.4 0.3 0.5 Normalized to: 0.2 I<sub>F</sub> Pulsed t<sub>pw</sub> = 100 μs Duty Cycle = 0.1 % 0.1 0.0 775 800 825 850 875 900 925 950 -40 -20 0 20 40 60 80 100 λ (nm) TA - AMBIENT TEMPERATURE (°C)

#### Fig. 5 Radiation Diagram





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## QEE122 QEE123

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.